

HD74LV2GT02A

Dual 2-input NOR Gates / CMOS Logic Level Shifter

REJ03D0138-0200Z (Previous ADE-205-663A (Z)) Rev.2.00 Oct.14.2003

Description

The HD74LV2GT02A has dual two-input NOR gates in an 8 pin package. The input protection circuitry on this device allows over voltage tolerance on the input, allowing the device to be used as a logic–level translator from 3.0 V CMOS Logic to 5.0 V CMOS Logic or from 1.8 V CMOS logic to 3.0 V CMOS Logic while operating at the high-voltage power supply. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- TTL compatible input level.

Supply voltage range: 3.0 to 5.5 V

Operating temperature range: -40 to +85°C

• Logic-level translate function

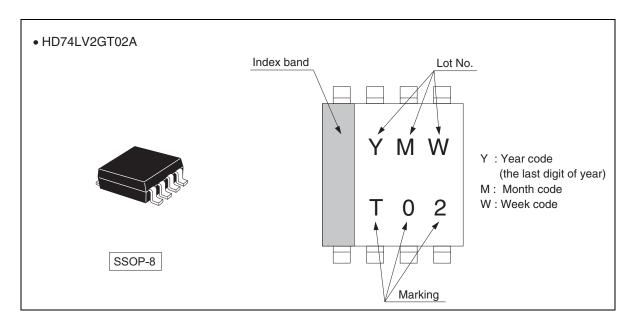
 $3.0 \text{ V CMOS logic} \rightarrow 5.0 \text{ V CMOS logic} (@V_{CC} = 5.0 \text{ V})$

1.8 V or 2.5 V CMOS logic \rightarrow 3.3 V CMOS logic (@V_{CC} = 3.3 V)

- All inputs V_{IH} (Max.) = 5.5 V (@V_{CC} = 0 V to 5.5 V) All outputs V_{O} (Max.) = 5.5 V (@V_{CC} = 0 V)
- Output current ± 6 mA (@V_{CC} = 3.0 V to 3.6 V), ± 12 mA (@V_{CC} = 4.5 V to 5.5 V)
- All the logical input has hysteresis voltage for the slow transition.
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LV2GT02AUSE	SSOP-8 pin	TTP-8DBV	US	E (3,000 pcs/reel)

Outline and Article Indication



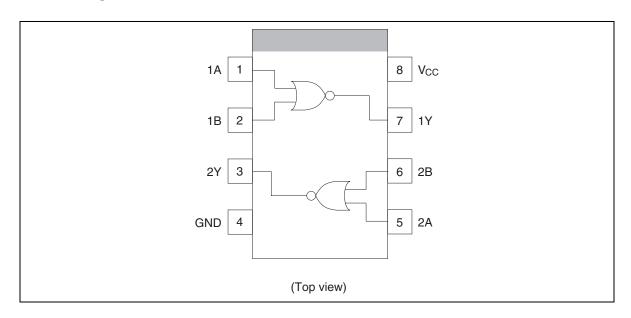
Function Table

Inputs

A	В	Output Y
L	L	Н
L	Н	L
Н	L	L
Н	Н	L

H : High level L : Low level

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V _{CC}	-0.5 to 7.0	V	
Input voltage range *1	VI	-0.5 to 7.0	V	
Output voltage range *1, 2	Vo	-0.5 to V_{CC} +0.5	V	Output : H or L
		-0.5 to 7.0		V _{CC} : OFF
Input clamp current	I _{IK}	-20	mA	V _I < 0
Output clamp current	I _{OK}	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	Io	±25	mA	$V_O = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±50	mA	
Maximum power dissipation at Ta = 25°C (in still air) *3	P _T	200	mW	
Storage temperature	Tstg	-65 to 150	°C	

Notes:

The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

HD74LV2GT02A

Recommended Operating Conditions

Item	Symbol	Ratings	Unit
Supply voltage	V _{CC}	3.0 to 5.5	V
Input voltage	V _{IN}	0 to 5.5	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to +85	°C
Input rise / fall time	t _r , t _f	0 to 100 (V _{CC} = 3.0 to 3.6 V)	ns
		0 to 20 (V _{CC} = 4.5 to 5.5 V)	

Electrical Characteristic

• $Ta = -40 \text{ to } 85^{\circ}C$

Item	Symbol	V _{CC} (V) *	Min	Тур	Max	Unit	Test condition
Input voltage	V _{IH}	3.0 to 3.6	1.5	_	_	V	
		4.5 to 5.5	2.0	_	_		
	V _{IL}	3.0 to 3.6	_	_	0.6	_	
		4.5 to 5.5	_	_	0.8		
Hysteresis voltage	V _H	3.3	_	0.10	_	V	$V_T^+ - V_T^-$
		5.0	_	0.15	_	_	
Output voltage	V _{OH}	Min to Max	V _{CC} -0.1	_	_	V	$I_{OH} = -50 \mu A$
		3.0	2.48	_	_		$I_{OH} = -6 \text{ mA}$
		4.5	3.8	_	_	_	$I_{OH} = -12 \text{ mA}$
	V _{OL}	Min to Max	_	_	0.1	_	$I_{OL} = 50 \mu A$
		3.0	_	_	0.44	_	I _{OL} = 6 mA
		4.5	_	_	0.55	_	I _{OL} = 12 mA
Input current	I _{IN}	0 to 5.5	_	_	±1	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Quiescent supply current	I _{CC}	5.5	_	_	10	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
	ΔI_{CC}	5.5	_	_	1.5	mA	One input $V_{IN} = 3.4 \text{ V}$, other input V_{CC} or GND
Output leakage current	I _{OFF}	0	_	_	5	μΑ	V _O = 5.5 V
Input capacitance	C _{IN}	5.0	_	2.5	_	pF	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

 $\bullet \quad V_{CC} = 3.3 \pm 0.3 \ V$

		Ta = 2	25°C		Ta = -	40 to 85°C		Test	FROM	ТО
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	7.0	11.0	1.0	13.0	ns	C _L = 15 pF	A or B	Υ
delay time	t _{PHL}	_	9.0	14.0	1.0	15.5	_	C _L = 50 pF	_	

• $V_{CC} = 5.0 \pm 0.5 \text{ V}$

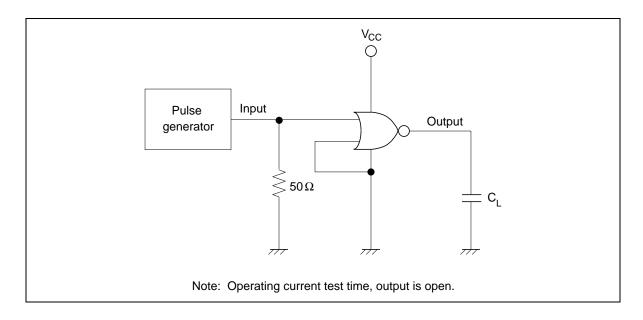
		Ta = 2	25°C		Ta = -4	40 to 85°C		Test	FROM	ТО
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	5.0	6.2	1.0	7.5	ns	C _L = 15 pF	A or B	Υ
delay time	t _{PHL}	_	6.5	9.0	1.0	10.0	_	C _L = 50 pF	_	

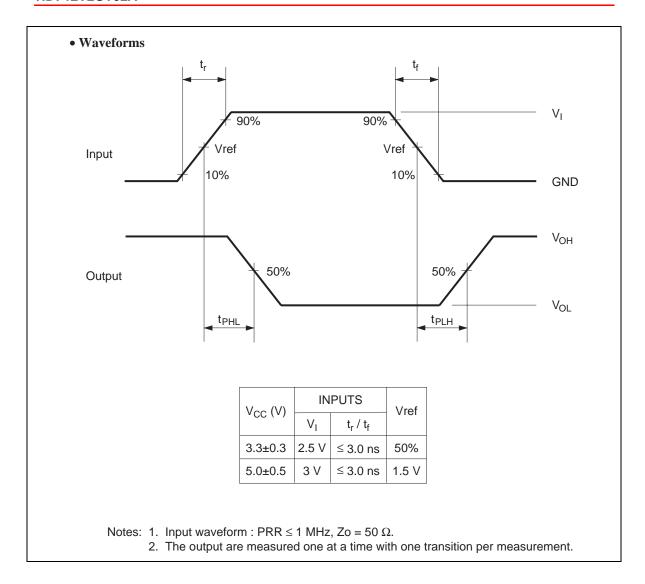
Operating Characteristics

• $C_L = 50 pF$

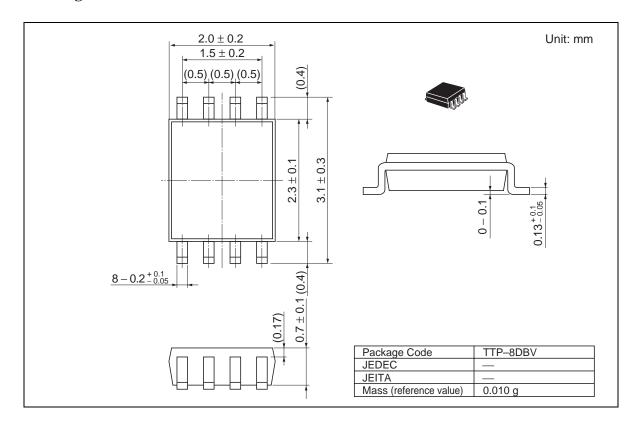
			$T_a = 2$	5°C			
Item	Symbol	V _{CC} (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation capacitance	C_{PD}	5.0	_	10.3	_	pF	f = 10 MHz

Test Circuit





Package Dimensions



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